IFW

PATENT
Customer No. 22,852
Attorney Docket No. 4329.3162

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)	
	)	
Tetsuya KUROSAWA	)	Group Art Unit: 2815
	)	
Application No.: 10/685,412	)	Examiner: Clark, Jasmine Jhihan B.
	)	
Filed: October 16, 2003	)	
	)	
For: SEMICONDUCTOR DEVICE WHOSE SEMICONDUCTOR CHIP HAS CHAMFERED BACKSIDE SURFACE EDGES AND METHOD OF MANUFACTURING THE SAME	)	

Commissioner for Patents
PO Box 1450
Washington, DC 22313-1450

Sir:

AMENDMENT

In reply to the Office Action mailed June 28, 2004, the period for response to which extends through September 28, 2004, please amend the application as follows. Applicant requests the Examiner's reconsideration in view of the remarks that follow:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims beginning on page 3 of this paper.

Remarks begin on page 7 of this paper.